

REVISIONS AA OO DESCRIPTION DATE DWN APVE G ECO-07-022131 05NOV07 LAM JW G1 REVISED PER ECO-09-021826 12SEP09 KK AE

HOUSING - HIGH TEMPERATURE THERMOPLASTIC, TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK BRIGHT TIN LEAD IN SOLDER AREA. 1.27µm [.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [.000050] MINIMUM THICK NICKEL. LIGHT EMITTING DIODE (LED) — DIFFUSED EPOXY LENS, .51 x .51[.020 x .020] CARBON STEEL WIREFRAME LEADS PLATED WITH 8.89µm[.000350] TIN/COPPER OVER 2.03µm[.000080] SILVER OVER 1.02µm[.000040] NICKEL UNDERPLATE OVER 2.03µm[.000080] COPPER UNDERPLATE.

2. JACK CAVITY CONFORMS TO FCC RULES AND

SUGGESTED PANEL OPENING DIMENSIONS.

SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR

SEE TABLE FOR COLOR OF LEDS AND NUMBER

6. THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.

OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

^	GREEN	_	1 406533 7		
<u></u>	GREEN	RED/GREEN	1 406533 0		
OBSOLETE	YELLOW	YELLOW	-406533-6-		
	YELLOW	_	-406533 3 -406533 2		
	_	GREEN			
	YELLOW	GREEN	406533-1		
	POSITION 2	POSITION 1	PART NUMBER		
	·	. PARI NUMBER			

INDICATOR COLOR

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 17SEP97 T. SPRINKLE		Tyco Electronics Corporation					
DIMENSIONS	TOLEDANOES HALLES	CHK T. SPRINKLE	17SEP97		Electronic:	S Harrisburg,	Pa 17105	5-3608	
DIMENSIONS: mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD M. DERSTINE	17SEP97	NAME		INVERTED MODU	JIAR JA	CK	
0 PLC ± - 1 PLC ± - 2 PLC ± 0.25[.010] 3 PLC ± 0.13[.005]		PRODUCT SPEC 108-1163-4 APPLICATION SPEC		ASSEMBLY, 1X1, LED					
_	4 PLC ± - ANGLES ± -	114-2154		SIZE		DRAWING NO			RESTRICTED TO
MATERIAL SEE NOTE 1	FINISH SEE NOTE 1	WEIGHT		A 1	00779	C -406533			
		CUSTOMER DRA	WING			scale 8:	1 SHEET	1 OF	1 REV G 1

AMP 4805 REV 31MAR2000

Mouser Electronics

Authorized Distributor

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TE Connectivity: 406533-1